

Leonardo 200 LD

**DIE ATTACH FILM LAMINATION
+ LINER REMOVAL SYSTEM**



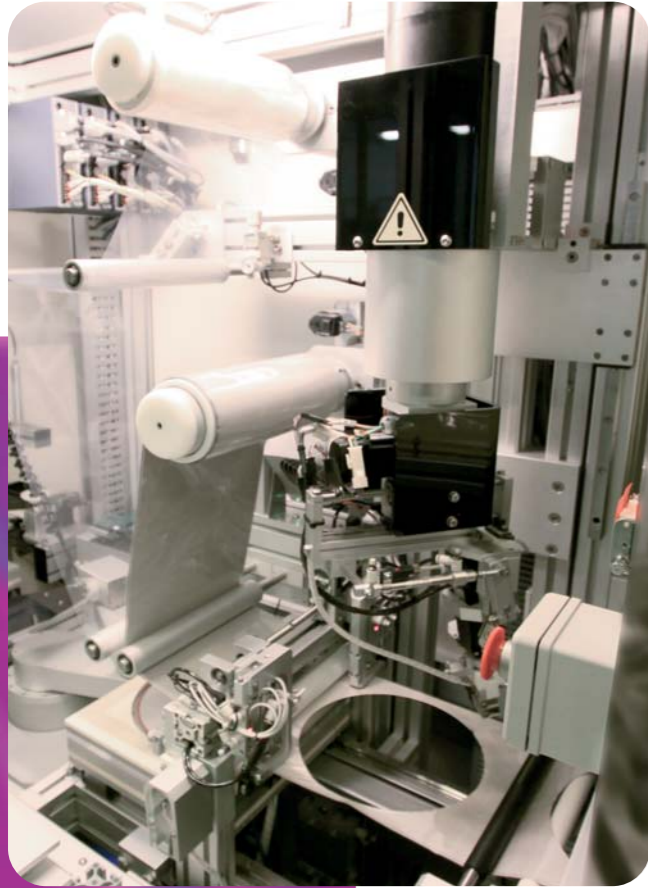
**microcontrol
electronic**

Milan - ITALY
www.microcontrol.org

Leonardo 200 LD

**DIE ATTACH FILM
AUTOMATIC AND SEMIAUTOMATIC
LAMINATION SYSTEM**

Film lamination Station



Loading Station



Microcontrol Electronic history

Established in 1976, Microcontrol Electronic introduced the **first worldwide automatic Taper and Detaper** on the market in 1984. Since then hundreds of equipment has been sold all over the world to the most important companies such as Atmel, IBM, Infineon, Intel, Micron, Triquint, Freescale, NXP, STM and TI. From this experience and improved technology we created **Leonardo 200 LD**. This system allows to laminate any kind of DIE ATTACH FILM

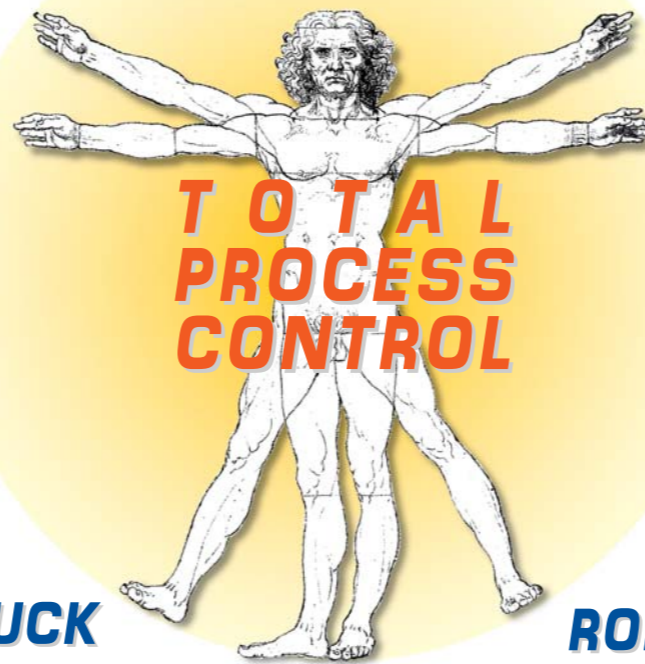
Liner removal station



LOWEST TAPE CONSUMPTION
"GAP CONTROL AND ROLL WIDTH OPTIMIZATION"

**LAMINATION
SPEED**

**LAMINATION
PRESSURE**



**CHUCK
TEMPERATURE**

**ROLLER
TEMPERATURE**

Process station top view



Leonardo 200 LD
is your solution!

Leonardo 200 LD

SYSTEM SPECIFICATIONS

| | |
|---------------------------------|--|
| WAFER SIZE | Up to 8" |
| THROUGHPUT | Process linked (average of 20 wfrs/h) |
| MINIMUM TAPE WIDTH | 6" - 170 mm 8" - 220 mm |
| DIMENSIONS | D1000 x W2500 x H1990 mm |
| WEIGHT | 1200 kg |
| SECS-GEM SEMI compliance | Standard |
| BUBBLE AND WRINKLE | Free |

System specifications are subject to change without prior notice



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9160.EMCG
ISO 9001:2008



9191.EMC2
ISO 14001:2004

